

N-Channel Enhancement Mode Field Effect Transistor

■ General Description

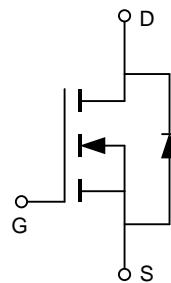
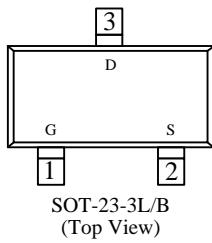
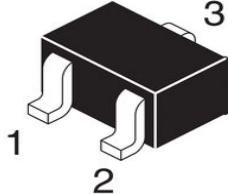
Product Summary		
V_{DSS}	I_D	$R_{DS(ON)}(m\Omega)$ TYP
20V	3.6A	65 @ $V_{GS} = 4.5V$
		90 @ $V_{GS} = 2.5V$

■ Features

- Super high dense cell design for low $R_{DS(ON)}$
- Rugged and reliable
- Simple drive requirement
- SOT-23-3L/B package

■ Package

- SOT-23-3L/B



■ Ordering Information

Part Number	Storage Temperature	Package	Devices Per Reel
LN2302	-55°C to +150°C	SOT-23-3L/B	3000

■ Absolute Maximum Ratings

(TA=25°C unless otherwise noted)

parameter	symbol	limit	unit
Drain-source voltage	V_{DS}	20	V
Gate-source voltage	V_{GS}	± 8	V
Drain current-continuous ^a @T _j =125°C-pulse d ^b	I_D	3.6	A
	I_{DM}	12	A
Drain-source Diode forward current	I_S	1.25	A
Maximum power dissipation	P_D	1.25	W
Operating junction Temperature range	T_j	-55—150	°C

■ Electrical Characteristics

(TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
OFF Characteristics						
Drain-source breakdown voltage	BV _{DSS}	V _{GS} =0V, I _D =250μA	20			V
Zero gate voltage drain current	I _{DSS}	V _{DS} =16V, V _{GS} =0V			1	μA
Gate-body leakage	I _{GSS}	V _{DS} =0V, V _{GS} =±8V			±100	nA
ON Characteristics						
Gate threshold voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	0.5	0.8	1.5	V
Drain-source on-state resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =2.8A		65	80	mΩ
		V _{GS} =2.5V, I _D =2.0A		90	110	
Forward transconductance	g _f	V _{GS} =5V, I _D =5A		5		S
Dynamic Characteristics						
Input capacitance	C _{iss}	V _{DS} =10V, V _{GS} =0V f=1.0MHz		586		pF
Output capacitance	C _{oss}			101		
Reverse transfer capacitance	C _{RSS}			59		
Switching Characteristics						
Turn-on delay time	t _{D(ON)}	V _{DD} =10V I _D =3.6A, V _{GEN} =4.5V R _L =10ohm R _{GEN} =10ohm		6.5		ns
Rise time	tr			32.1		
Turn-off delay time	t _{D(OFF)}			58.4		
Fall time	tf			48		
Total gate charge	Q _g	V _{DS} =10V, I _D =1A V _{GS} =4.5V		6		nC
Gate-source charge	Q _{gs}			1.35		
Gate-drain charge	Q _{gd}			1.5		
Drain-Source Diode Characteristics						
Diode forward voltage	V _{SD}	V _{GS} =0V, I _s =1.25A		0.84	1.2	V

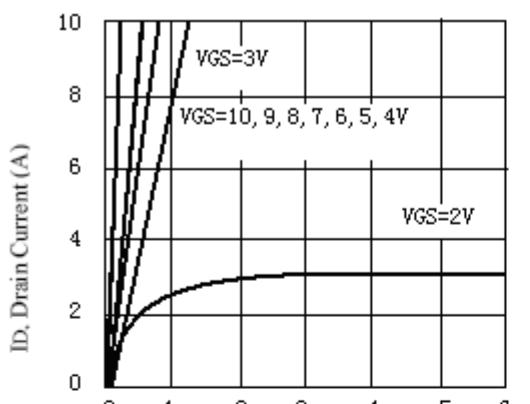
Notes:

- surface mounted on FR4 board, t≤10sec
- pulse test:pulse width≤300μs,duty≤2%
- guaranteed by design, not subject to production testing

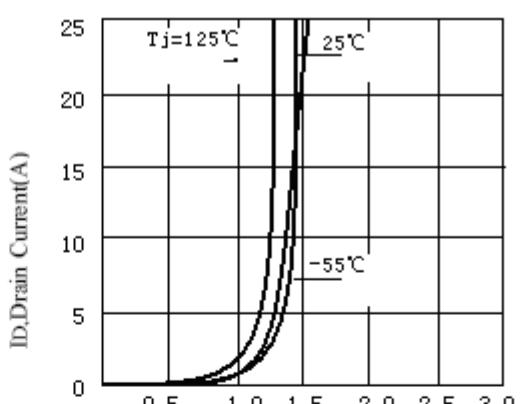
■ Thermal Characteristics

Thermal Resistance junction-to ambient	R _{th JA}	100	°C/W
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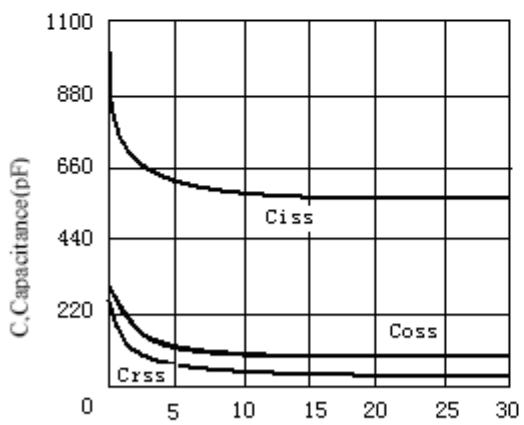
■ Typical Performance Characteristics



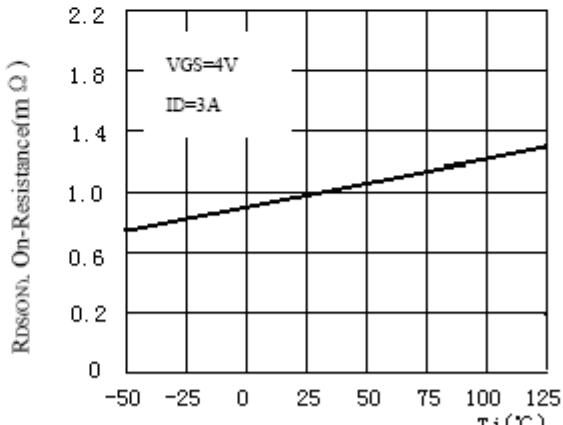
V_{DS}, Drain-to-Source Voltage (V)
Figure 1. Output Characteristics



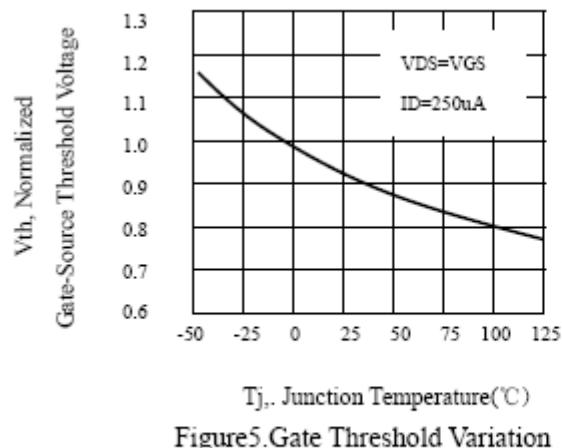
V_{Gs}, Gate-to-source Voltage (V)
Figure 2. Transfer Characteristics



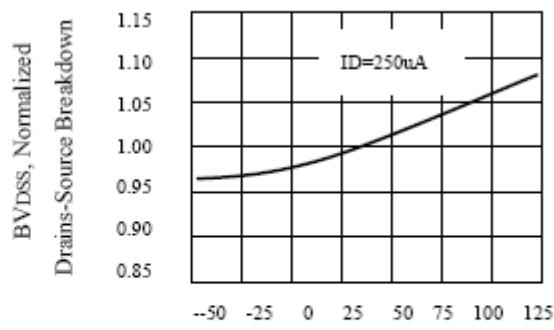
V_{GS}, Drain-to Source Voltage
Figure3. Capacitance



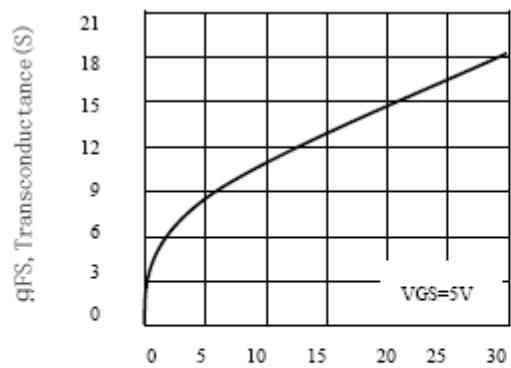
R_{DSON}, On-Resistance(mΩ)
T_j(°C)
Figure4. On-Resistance Variation with Temperature



T_j, Junction Temperature(°C)
Figure5.Gate Threshold Variation
With Temperature

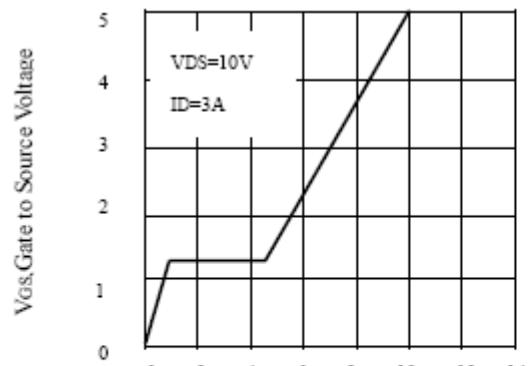


T_j, Junction Temperature (°C)
Figure6.Breakdown Voltage Variation
With Temperature



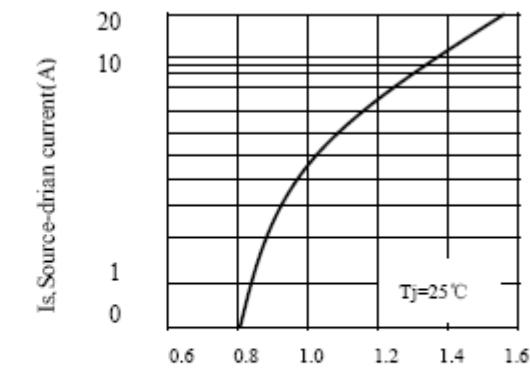
IDS, Drain-Source Current (A)

Figure 7. Transconductance Variation
With Drain Current



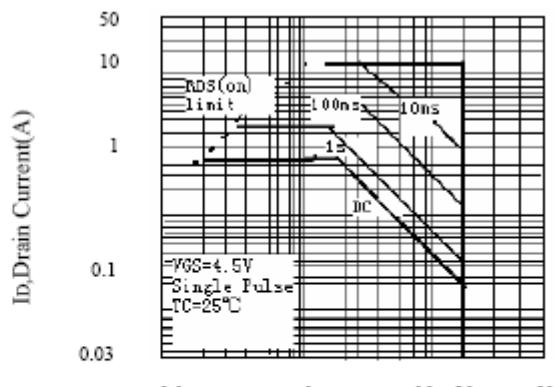
Qg, Total Gate Charge (nC)

Figure 9. Gate Charge



VSD, Body Diode Forward Voltage

Figure 8. Body Diode Forward Voltage
Variation with Source Current

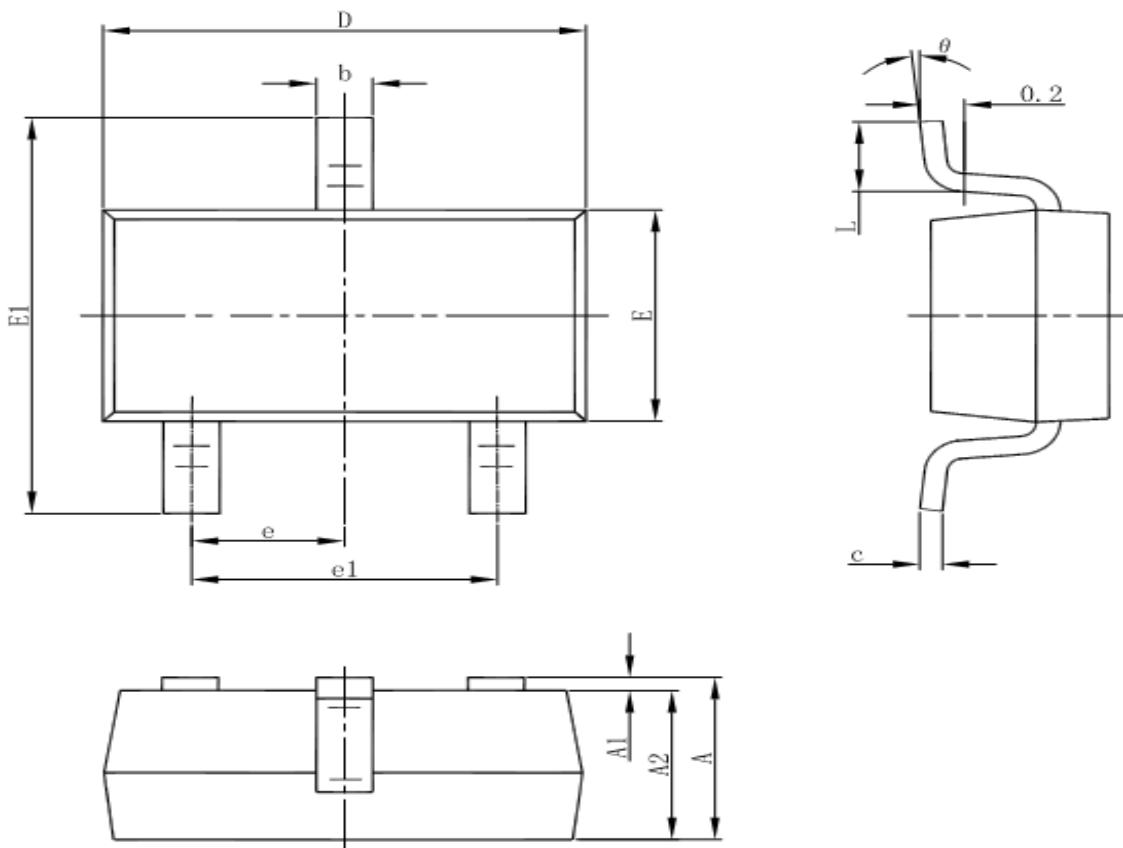


VDS, Drain-Source Voltage(V)

Figure 10. Maximum Safe Operating Area

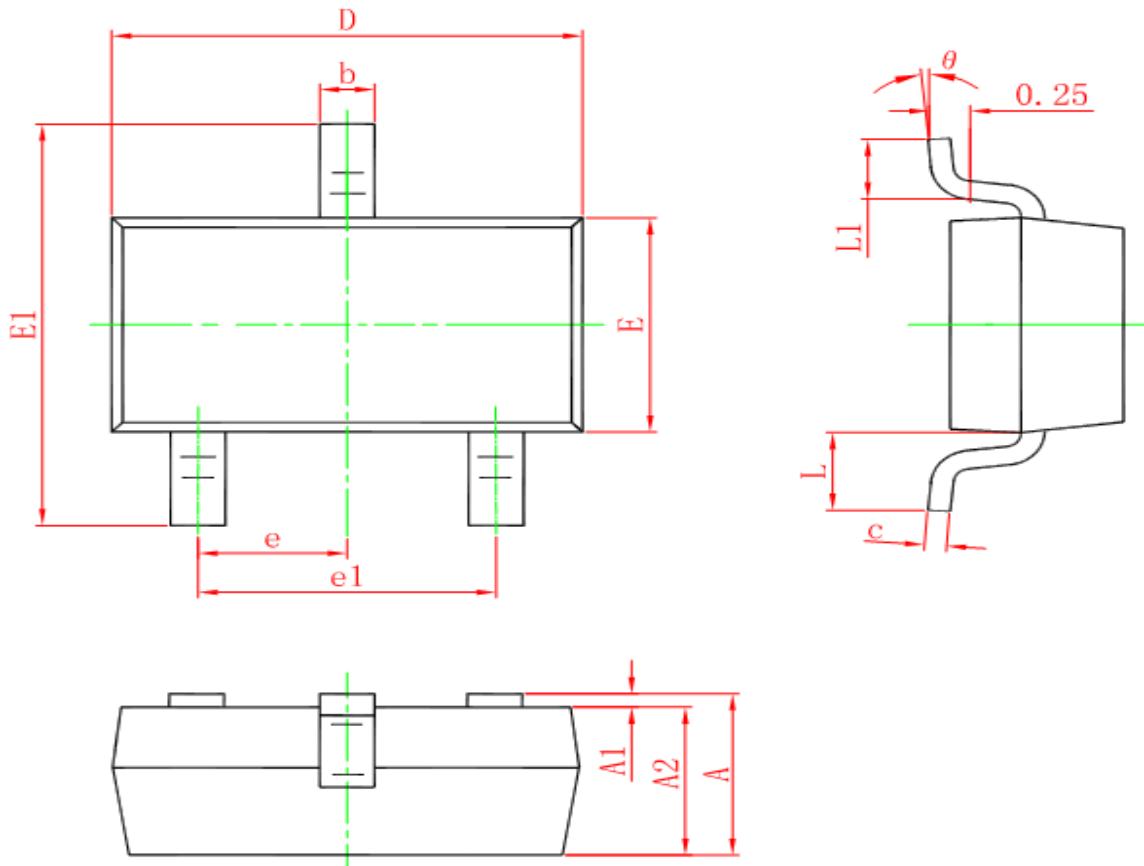
■ Package Information

- SOT-23-3L



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950(BSC)		0.037(BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°

● SOT-23-3B



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP.		0.037 TYP.	
e1	1.800	2.000	0.071	0.079
L	0.550 REF.		0.022 REF.	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°